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# **1SS119**

# Silicon Epitaxial Planar Diode for High Speed Switching



ADE-208-180B (Z)

Rev.2 Sep. 2000

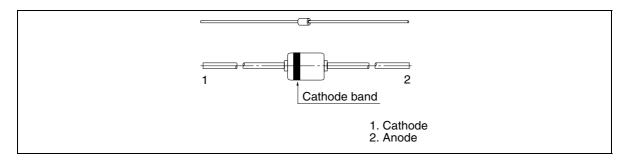
## **Features**

- Low capacitance. (C = 3.0 pF max)
- Short reverse recovery time.  $(t_{rr} = 3.5 \text{ ns max})$
- Small glass package (MHD) enables easy mounting and high reliability.

## **Ordering Information**

| Type No. | Cathode band | Package Code |  |
|----------|--------------|--------------|--|
| 1SS119   | Light Blue   | MHD          |  |

## Pin Arrangement



## **1SS119**

# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

| Item                                      | Symbol          | Value       | Unit |  |
|---|-----------------|-------------|------|--|
| Peak reverse voltage                      | V <sub>RM</sub> | 35          | V    |  |
| Reverse voltage                           | V <sub>R</sub>  | 30          | V    |  |
| Average rectified current                 | I <sub>o</sub>  | 150         | mA   |  |
| Peak forward current                      | I <sub>FM</sub> | 450         | mA   |  |
| Non-Repetitive peak forward surge current | FSM *           | 1           | А    |  |
| Power dissipation                         | Pd              | 250         | mW   |  |
| Junction temperature                      | Tj              | 175         | °C   |  |
| Storage temperature                       | Tstg            | -65 to +175 | °C   |  |

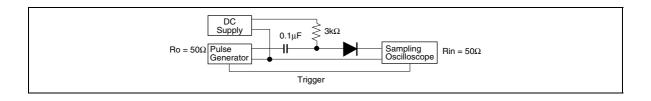
Note: Within 1s forward surge current.

## **Electrical Characteristics**

 $(Ta = 25^{\circ}C)$ 

| Item                  | Symbol         | Min | Тур | Max | Unit | Test Condition  |
|-----------------------|----------------|-----|-----|-----|------|---|
| Forward voltage       | V <sub>F</sub> | _   | _   | 0.8 | V    | I <sub>F</sub> = 10 mA  |
| Reverse current       | I <sub>R</sub> | _   | _   | 0.1 | μΑ   | V <sub>R</sub> = 30 V   |
| Capacitance           | С              | _   | _   | 3.0 | pF   | V <sub>R</sub> = 1 V, f = 1 MHz   |
| Reverse recovery time | t,, *          | _   | _   | 3.5 | ns   | $I_{\rm F} = 10 \text{ mA}, V_{\rm R} = 6 \text{ V}, R_{\rm L} = 50 \Omega$ |

Note: Reverse recovery time test circuit



## **Main Characteristic**

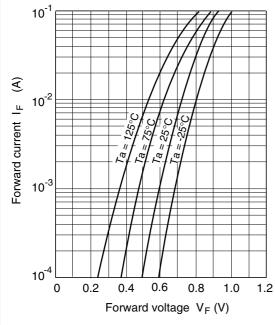


Fig.1 Forward current Vs. Forward voltage

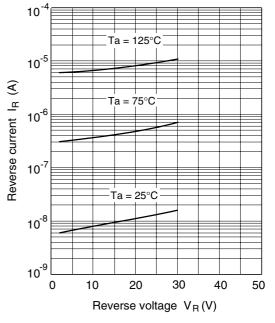


Fig.2 Reverse current Vs. Reverse voltage

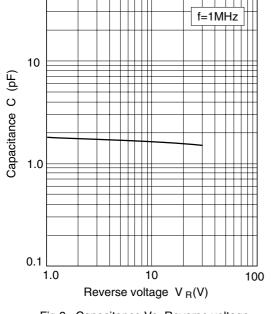
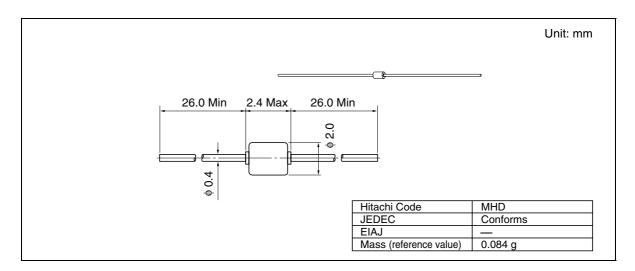


Fig.3 Capacitance Vs. Reverse voltage

# **1SS119**

# **Package Dimensions**



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